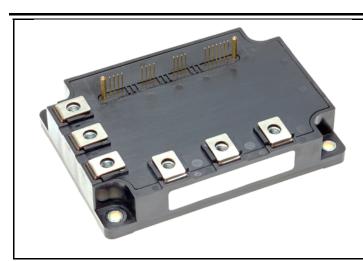


<Intelligent Power Modules>

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FLAT-BASE TYPE INSULATED PACKAGE



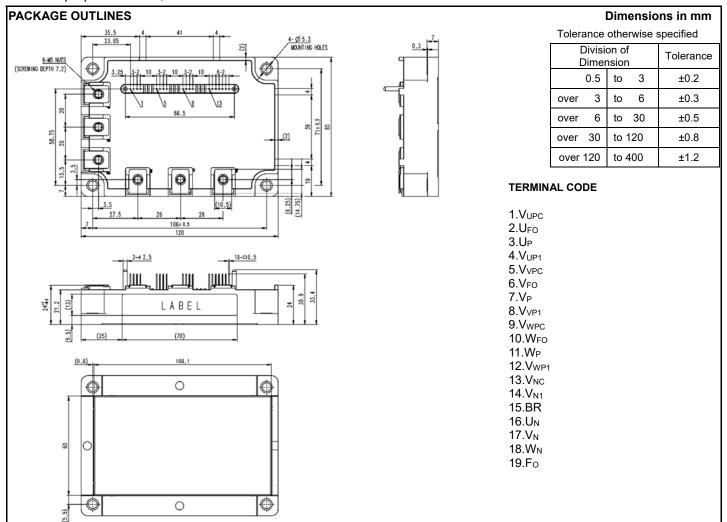
FEATURE

- a) Adopting Full-Gate CSTBT chip.
- b) The over-temperature protection which detects the chip surface temperature of CSTBT is adopted.
- c) Error output signal is available from each protection upper and lower arm of IPM.
- d) Outputting an error signal corresponding to the abnormal state (error mode identification)

This product is compliant with the Restriction of the Use of Certain Hazardous Substances in Electrical and Electronic Equipment (RoHS) directive 2011/65/EU.

APPLICATION

General purpose inverter, servo drives and other motor controls



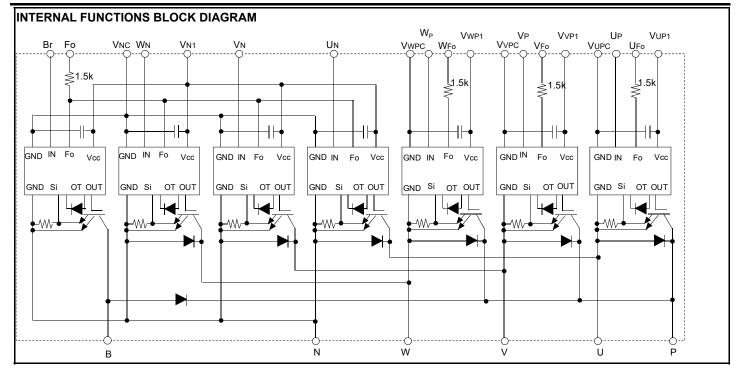
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Publication date: Nov. 2017

PM200RG1C065

HIGH POWER SWITCHING USE

INSULATED TYPE



MAXIMUM RATINGS (Tvj = 25°C, unless otherwise noted)

INVERTER PART

| 1144 = 141 744 | | | | | | | | |
|------------------|---------------------------------------|--|------------|------|--|--|--|--|
| Symbol | Parameter | Conditions | Ratings | Unit | | | | |
| V _{CES} | Collector-Emitter Voltage | V _D =15 V, V _{CIN} =15 V | 650 | V | | | | |
| Ic | Collector Current | T _C =25 °C | 200 | ^ | | | | |
| I _{CRM} | Collector Current | Pulse | 400 | Α | | | | |
| P _{tot} | Total Power Dissipation | T _C =25 °C | 735 | W | | | | |
| l _E | Emitter Current | T _C =25 °C | 200 | _ | | | | |
| I _{ERM} | (Free-wheeling Diode Forward current) | Pulse | 400 | Α | | | | |
| Tvj | Junction Temperature | | -20 ~ +150 | °C | | | | |

^{*:} Tc measurement point is just under the chip.

BRAKE PART

| Symbol | Parameter | Conditions | Ratings | Unit |
|--------------------|--------------------------------|--|------------|------|
| V _{CES} | Collector-Emitter Voltage | V _D =15 V, V _{CIN} =15 V | 650 | V |
| I _C | Collector Current | T _C =25 °C | 100 | _ |
| I _{CRM} | Collector Current | Pulse | 200 | A |
| P _{tot} | Total Power Dissipation | T _C =25 °C | 446 | W |
| V _{R(DC)} | Diode Rated Reverse DC Voltage | T _C =25 °C | 650 | V |
| I _F | Diode Forward Current | T _C =25 °C | 100 | Α |
| Tvj | Junction Temperature | | -20 ~ +150 | °C |

 $[\]ensuremath{^{*:}}$ Tc measurement point is just under the chip.

CONTROL PART

| Symbol | Parameter | Conditions | Ratings | Unit |
|-----------------|-----------------------------|--|---------|------|
| V_D | Supply Voltage | Applied between: V _{UP1} -V _{UPC} , V _{VP1} -V _{VPC} , V _{WP1} -V _{WPC} , V _{N1} -V _{NC} | 20 | V |
| V_{CIN} | Input Voltage | Applied between: U_P - V_{UPC} , V_P - V_{VPC} , W_P - V_{WPC} , U_N , V_N , W_N , W_N , W_N | 20 | V |
| V_{FO} | Fault Output Supply Voltage | Applied between: U _{FO} -V _{UPC} , V _{FO} -V _{VPC} , W _{FO} -V _{WPC} , Fo-V _{NC} | 20 | V |
| I _{FO} | Fault Output Current | Sink current at U _{FO} , V _{FO} , W _{FO} , Fo terminals | 20 | mA |

PM200RG1C065

HIGH POWER SWITCHING USE

INSULATED TYPE

TOTAL SYSTEM

| Symbol | Parameter | Conditions | Ratings | Unit |
|-------------------|--------------------------------|--|------------|------|
| $V_{CC(PROT)}$ | Supply Voltage Protected by SC | V _D =13.5 V∼16.5 V, Inverter Part, Tvj=+125°C start | 400 | V |
| T_{stg} | Storage Temperature | - | -40 ~ +125 | °C |
| Tc | Operating Case Temperature | - | -20 ~ +125 | °C |
| V _{isol} | Isolation Voltage | 60Hz, Sinusoidal, Charged part to Base plate, AC 1min, RMS | 2500 | V |

^{*:} Tc measurement point is just under the chip.

THERMAL RESISTANCE

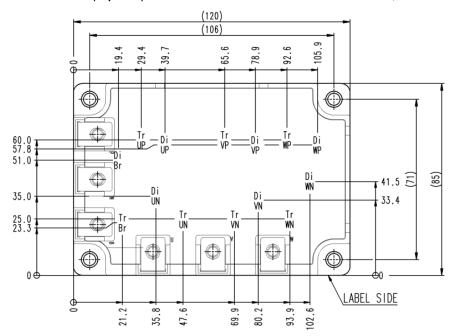
| Symbol | Parameter | Conditions | Limits | | | Llmit |
|----------------------|----------------------------|---|--------|------|------|--------|
| | | Conditions | Min. | Тур. | Max. | Unit |
| $R_{th(j-c)Q}$ | Thermal Resistance | Inverter, Junction to case, IGBT, per 1 element (Note1) | - | - | 0.17 | |
| $R_{th(j-c)D}$ | | Inverter, Junction to case, FWD, per 1 element (Note1) | - | - | 0.27 | K/W |
| $R_{th(j-c)Q}$ | | Brake, Junction to case, IGBT, per 1 element (Note1) | - | - | 0.28 | |
| $R_{th(j-c)D}$ | | Brake, Junction to case, FWD, per 1 element (Note1) | - | - | 0.44 | |
| R _{th(c-s)} | Contact Thermal Resistance | Case to heat sink, per 1 module, | - | 8.4 | _ | K/kW |
| | | Thermal grease applied (Note.1, 2) | | | | IVIXVV |

Note1. If you use this value, $R_{\text{th(s-a)}}\,\text{should}$ be measured just under the chips.

Note2. Typical value is measured by using thermally conductive grease of λ =0.9W/(m·K), $D_{\text{(C-S)}}$ =50 μ m.

CHIP LOCATION (Top view)

Dimension in mm, torelance: ±1mm



Tr** : IGBT Di** : FWD

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PM200RG1C065

HIGH POWER SWITCHING USE

INSULATED TYPE

ELECTRICAL CHARACTERISTICS (Tvj= 25°C, unless otherwise noted)

INVERTER PART

| Cumbal | Parameter | Conditions | | | Limits | | | Unit |
|--------------------|--------------------------------------|---|-------------|------------|-----------|------|------|------|
| Symbol | Parameter | | | | Min. | Тур. | Max. | Unit |
| | | V -45 V I -200 A | T:-05 °C | Terminal | - | - | 2.0 | |
| V | Collector-Emitter Saturation Voltage | V _D =15 V, I _C =200 A | Tvj=25 °C | Chip | - | 1.25 | - | V |
| V _{CEsat} | · · | V _{CIN} =0 V, Pulsed, (Fig.1) | Tvj=125 °C | Terminal | - | - | 2.25 | V |
| | | V _{CIN} -0 V, Fuisea, (Fig. 1) | 1 Vj=125 C | Chip | 1 | 1.33 | - | |
| V | Emitter-Collector Voltage | V _D =15 V, I _E =200A, | Tvj=25 °C | Terminal | - | - | 2.1 | V |
| | | | | Chip | ı | 1.40 | - | |
| V _{EC} | | V _{CIN} = 15 V, pulsed, (Fig.2) Tvj=1. | Tvi=125 °C | Terminal | ı | - | 2.2 | |
| | | | 1 Vj=125 C | Chip | ı | 1.45 | ı | |
| t _{on} | | V _D =15 V, V _{CIN} =0 V↔15 V, | | 0.3 | 0.8 | 1.2 | | |
| t _{rr} | | V _{CC} =300 V, I _C =200A, | | - | - 0.2 0.6 | 0.65 | | |
| $t_{c(on)}$ | Switching Time | Tvj=125 °C, | | - | 0.2 | 0.75 | μs | |
| t _{off} | | Inductive Load | | | - | 0.8 | 2.3 | |
| $t_{c(off)}$ | (Fig.3, 4) | | - - - | | 1 | 0.12 | 0.4 | |
| | Collector-Emitter Cut-off Current | V _{CE} =V _{CES} , V _D =15 V, V _{CIN} =15 V (Fig.5) | | Tvj=25 °C | - | - | 1 | mΛ |
| I _{CES} | | | | Tvj=125 °C | - | - | 10 | mA |

BRAKE PART

| Cumhal | Parameter | Conditions | | | Limits | | | 11 |
|--------------------|--------------------------------------|--|---------------|------------|--------|------|------|------|
| Symbol | Parameter | Condition | is | | Min. | Тур. | Max. | Unit |
| | | V _D =15 V, I _C =100A | Tvj=25 °C | Terminal | - | - | 1.75 | |
| ., | | V _D =13 V, 1 _C =100A | 1 0 20 0 | Chip | - | 1.25 | - | ., |
| V _{CEsat} | Collector-Emitter Saturation Voltage | V _{CIN} =0 V, Pulsed, (Fig.1) | Tvj=125 °C | Terminal | - | - | 2.0 | V |
| | | | | Chip | - | 1.33 | - | |
| | Dieda Farmand Malla an | Tvj=25 °C Tvj=125 °C Tvj=125 °C | Tvj=25 °C | Terminal | - | - | 1.95 | V |
| \/ | | | | Chip | - | 1.40 | - | |
| V_{FM} | Diode Forward Voltage | | T : 405 00 | Terminal | - | - | 2.05 | |
| | | | 1 V J – 125 C | Chip | - | 1.45 | - | |
| | 0.11 | V _{CE} =V _{CES} , V _D =15 V, V _{CIN} =15 V (Fig.5) | | Tvj=25 °C | - | - | 1 | |
| I _{CES} | Collector-Emitter Cut-off Current | | | Tvj=125 °C | - | - | 10 | mA |

<Intelligent Power Modules>

PM200RG1C065

HIGH POWER SWITCHING USE

INSULATED TYPE

ELECTRICAL CHARACTERISTICS (Tvj = 25°C, unless otherwise noted)

CONTROL PART

| Symbol | Doromotor | Conditions | Conditions | | Limits | | |
|---------------------|----------------------------------|---|---|------|--------|------|------|
| Gyiriboi | Parameter | Conditions | | | Тур. | Max. | Unit |
| | | V -45 V V -45 V | V _{P1} -V _{PC} | - | 4 | 6 | |
| | Oine et a Communit | V _D =15 V, V _{CIN} =15 V | V _{N1} -V _{NC} | - | 16 | 24 | |
| I _D | Circuit Current | V _D =15 V, V _{CIN} =0 V←15 V, V _{CC} =400 V | V _{P1} -V _{PC} | - | 26 | 31 | mA |
| | | I _C =0A, Tvj=125 °C, f _C ≤20kHz | V _{N1} -V _{NC} | - | 94 | 110 | |
| $V_{th(ON)}$ | Input ON Threshold Voltage | Applied between: | | 1.2 | 1.5 | 1.8 | V |
| $V_{th(OFF)}$ | Input OFF Threshold Voltage | $U_{P}\text{-}V_{UPC},V_{P}\text{-}V_{VPC},W_{P}\text{-}V_{WPC},U_{N},V_{N},W_{N},$ | Br-V _{NC} | 1.7 | 2.0 | 2.3 |] V |
| 00 | Object Circuit Trip Level | -20≤Tvj≤125 °C, V _D =15 V (Fig.3, 6) | Inverter | 400 | - | - | _ |
| SC | Short Circuit Trip Level | | Brake | 200 | - | - | A |
| t _{d(SC)} | Short Circuit Current Delay Time | V _D =15 V, Tvj=125 °C (Fig.3, 6) | V _D =15 V, Tvj=125 °C (Fig.3, 6) | | 2.0 | - | μs |
| ОТ | Over Temperature Protection | Detect temperature of IGBT chip surface | Trip level | 150 | - | - | °C |
| OT _(hys) | | | Hysteresis | - | 20 | - | |
| UV _t | Supply Circuit | | Trip level | 11.0 | 12.0 | 12.7 | V |
| UV _r | Under-Voltage Protection | - | Reset level | - | 12.5 | - | V |
| I _{FO(H)} | Facility Control of Community | | | - | - | 0.01 | |
| I _{FO(L)} | Fault Output Current | V _D =15 V, V _{FO} =15 V (Note3) | | - | 10 | 15 | - mA |
| | | | ОТ | - | 8.0 | - | |
| t _{FO} | Fault Output Pulse Width | V _D =15 V (Note3) | UV | - | 4.0 | - | ms |
| | | | sc | - | 2.0 | - | |

Note3. Fault output is given only when the internal SC, OT & UV protections schemes of either upper or lower arm device operate to protect it.

MECHANICAL RATINGS AND CHARACTERISTICS

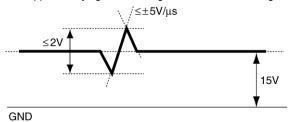
| Symbol | Parameter | Conditions | | Unit | | |
|--------|-----------------|-------------------------------|-----|------|------|--------|
| | | Conditions | | Тур. | Max. | Unit |
| Ms | Mounting Torque | Mounting part screw : M5 | 2.5 | 3.0 | 3.5 | N•m |
| M_t | Mounting Torque | Main terminal part screw : M5 | 2.5 | 3.0 | 3.5 | INTIII |
| m | mass | - | - | 425 | - | g |

RECOMMENDED CONDITIONS FOR USE

| Symbol | Parameter | Conditions | Recommended value | Unit |
|----------------------|---------------------------------|--|-------------------|------|
| V _{CC} | Supply Voltage | Applied across P-N terminals | ≤ 400 | V |
| V _D | Control Supply Voltage | Applied between: V _{UP1} -V _{UPC} , V _{VP1} -V _{VPC} , V _{WP1} -V _{WPC} ,V _{N1} -V _{NC} (Note4) | 15.0±1.5 | V |
| V _{CIN(ON)} | Input ON Voltage | Applied between : | ≤ 0.8 | V |
| $V_{CIN(OFF)}$ | Input OFF Voltage | U_P - V_{UPC} , V_P - V_{VPC} , W_P - V_{WPC} , U_N , V_N , W_N , Br - V_{NC} | ≥ 9.0 | v |
| f _{PWM} | PWM Input Frequency | Using Application Circuit of Fig. 8 | ≤ 20 | kHz |
| t _{dead} | Arm Shoot-through Blocking Time | For IPM's each input signals (Fig.7) | ≥ 2.0 | μs |

This product is compliant with the Restriction of the Use of Certain Hazardous Substances in Electrical and Electronic Equipment (RoHS) directive 2011/65/EU.

Note4. With ripple satisfying the following conditions: dv/dt swing ≤ ±5 V/µs, Variation ≤ 2 V peak to peak



PRECAUTIONS FOR TESTING

- 1. Before applying any control supply voltage (V_D), the input terminals should be pulled up by resistors, etc. to their corresponding supply voltage and each input signal should be kept off state.
 - After this, the specified ON and OFF level setting for each input signal should be done.
- 2. When performing "SC" tests, the turn-off surge voltage spike at the corresponding protection operation should not be allowed to rise above V_{CES} rating of the device.

(These test should not be done by using a curve tracer or its equivalent.)

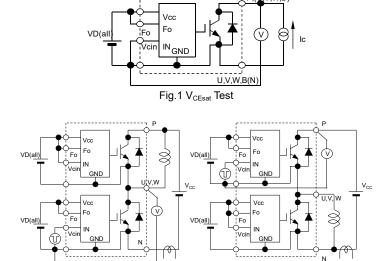
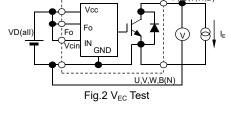


Fig.3 Switching time and SC test circuit



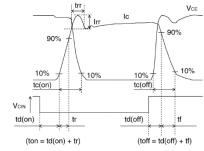


Fig.4 Switching time test waveform

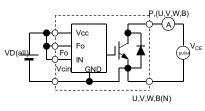


Fig.5 I_{CES} Test

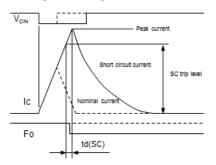
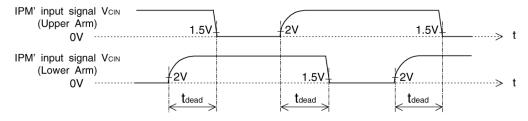


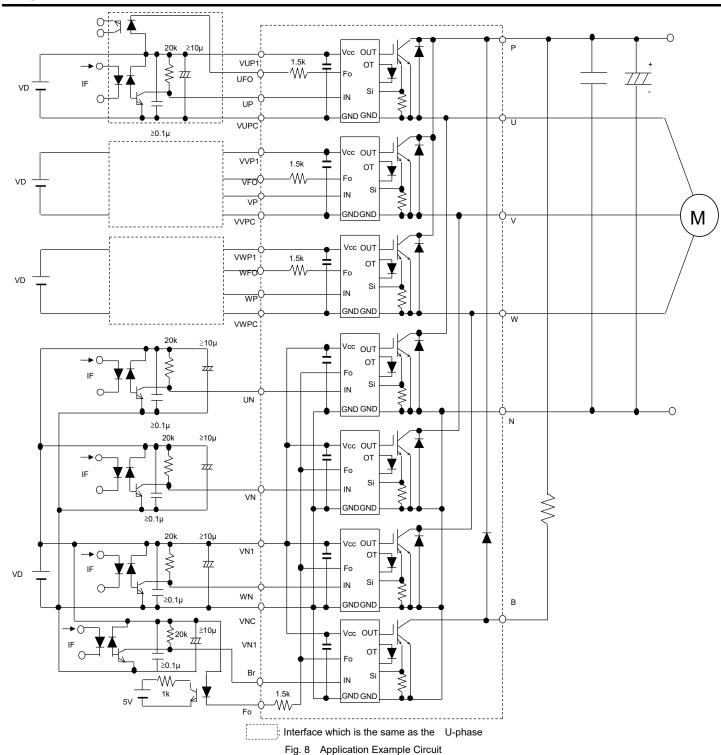
Fig.6 SC test waveform



1.5V: Input on threshold voltage Vth(on) typical value, 2V: Input off threshold voltage Vth(off) typical value

Fig. 7 Dead time measurement point example

INSULATED TYPE

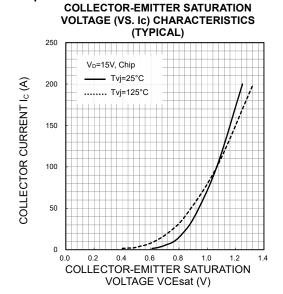


NOTES FOR STABLE AND SAFE OPERATION;

- Design the PCB pattern to minimize wiring length between opto-coupler and IPM's input terminal, and also to minimize the stray capacity between the input and output wirings of opto-coupler.
- · Connect low impedance capacitor between the Vcc and GND terminal of each fast switching opto-coupler.
- Fast switching opto-couplers: t_{PLH} , $t_{PHL} \le 0.8 \mu s$, Use High CMR type.
- Slow switching opto-coupler: CTR > 100% (*can be applied to Brake part input signal, in this case, resistor should be selected properly).
- Use 4 isolated control power supplies (V_D). Also, care should be taken to minimize the instantaneous voltage charge of the power supply.
- Make inductance of DC bus line as small as possible, and minimize surge voltage using snubber capacitor between P and N terminal.

INSULATED TYPE

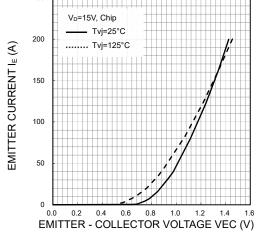
PERFORMANCE CURVES Inverter part

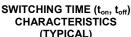


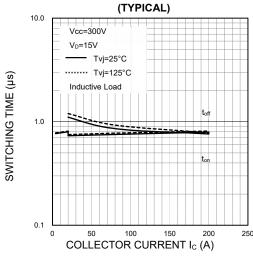
(TYPICAL) 250 V_D=15V, Chip 200 Tvi=125°C

FREE WHEELING DIODE FORWARD

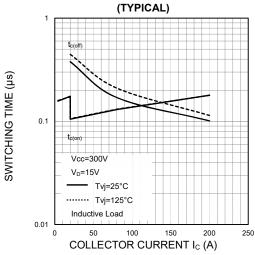
CHARACTERISTICS



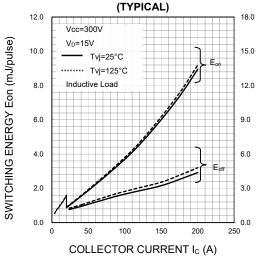




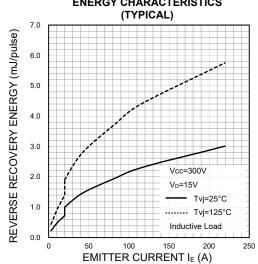
SWITCHING TIME $(t_{c(on)}, t_{c(off)})$ **CHARACTERISTICS**



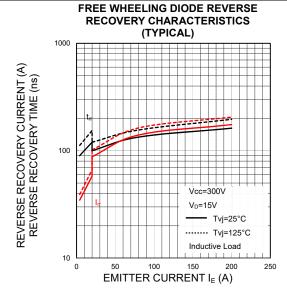
SWITCHING ENERGY CHARACTERISTICS

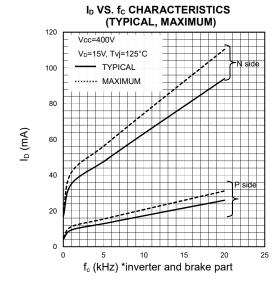


FREE WHEELING DIODE REVERSE RECOVERY **ENERGY CHARACTERISTICS**

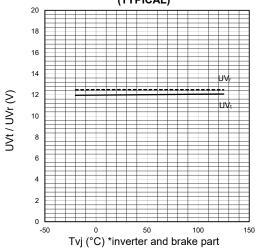


SWITCHING ENERGY Eoff (mJ/pulse)

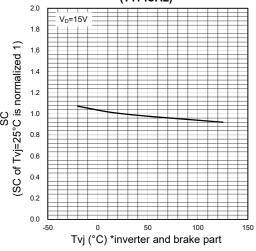




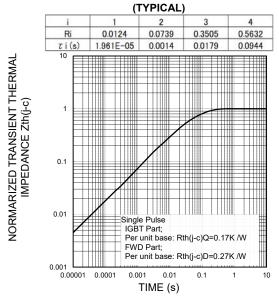






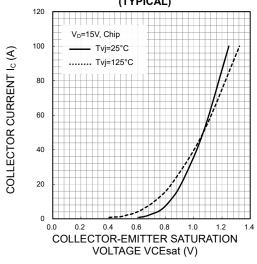


TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS



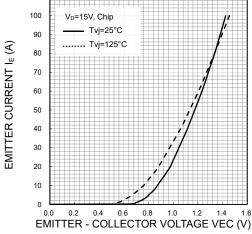
PERFORMANCE CURVES Brake part

COLLECTOR-EMITTER SATURATION VOLTAGE (VS. Ic) CHARACTERISTICS (TÝPICAL)

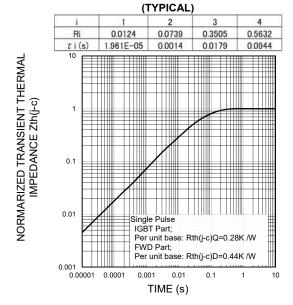


CHARACTERISTICS (TYPICAL) 110 100 V_D=15V, Chip Tvj=25°C .. Tvj=125°C 80

FREE WHEELING DIODE FORWARD



TRANSIENT THERMAL IMPEDANCE **CHARACTERISTICS**



PM200RG1C065

HIGH POWER SWITCHING USE INSULATED TYPE

Keep safety first in your circuit designs!

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